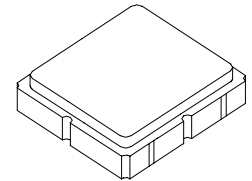


- *Low-loss SAW Filter*
- *3.8 x 3.8 x 1.4 mm Surface-mount Package*
- *Complies with Directive 2002/95/EC (RoHS)*



SF2180D

700 MHz SAW Filter



SM3838-8

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage Between any Two Active Terminals	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

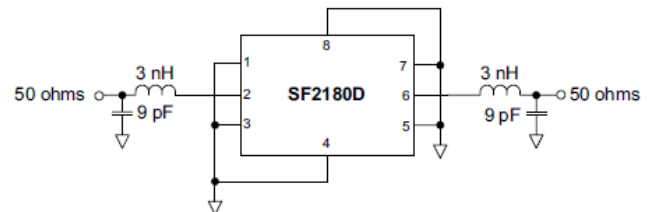
Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C			700		MHz
Passband Insertion Loss	IL				6.0	dB
3 dB Bandwidth			3.8		6.0	MHz
Phase, 698.25 to 701.75 MHz				linear		deg _{P-P}
VSWR, 698.10 to 701.90 MHz					2:1	
40 dB Bandwidth					12	MHz
Operating Temperature Range	T_A		-40		+85	°C
Impedance at f_C :						
Source, Single-ended				50 ohm		
Load, Single-ended				50 ohm		

Case Style	SM3838-8 3.8 x 3.8 mm Nominal Footprint		
Lid Symbolization, Y=year, WW=week, S=shift, Dot=pin 1 indicator	899, YWWS		
Standard Reel Quantity	Reel Size 7 Inch	1000 Pieces/Reel	
	Reel Size 13 Inch	3000 Pieces/Reel	

Electrical Connections

Connection	Terminals
Input	1 or 2
Output	5 or 6
Case Ground	All but selected in/out

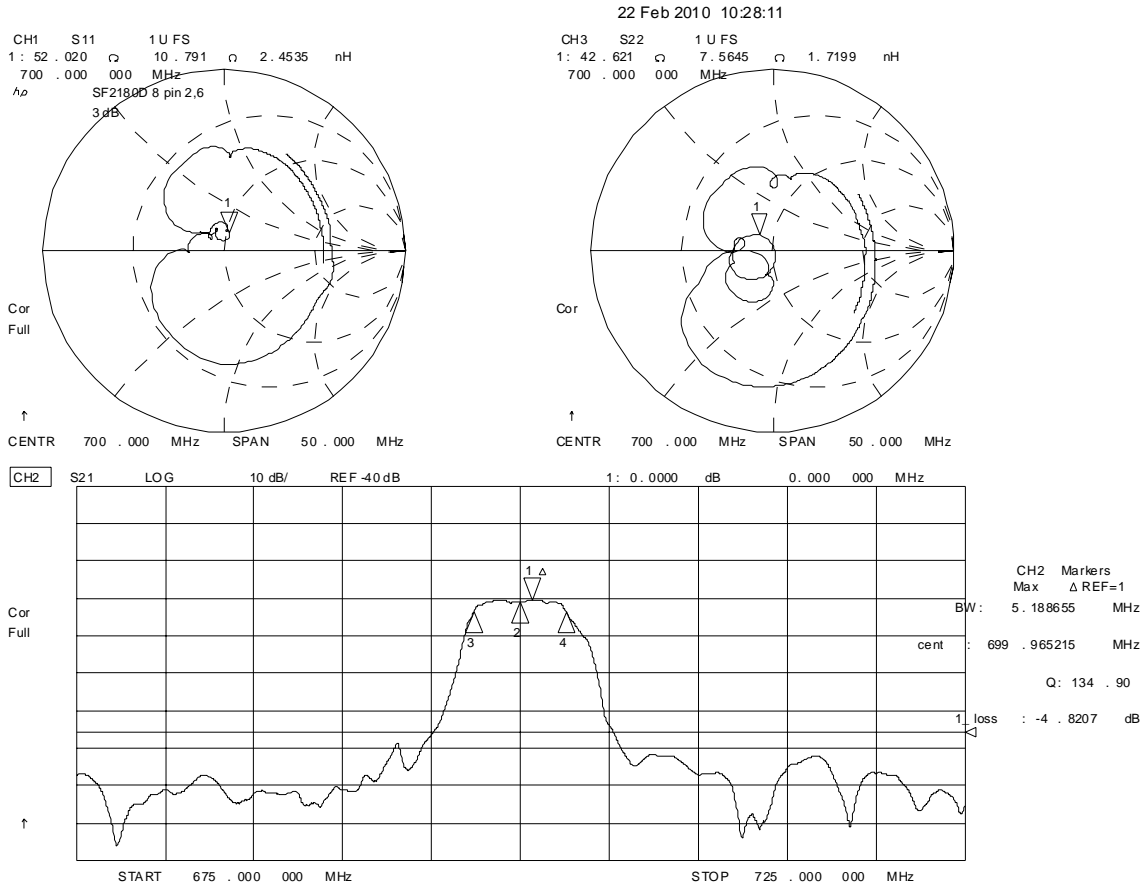


 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

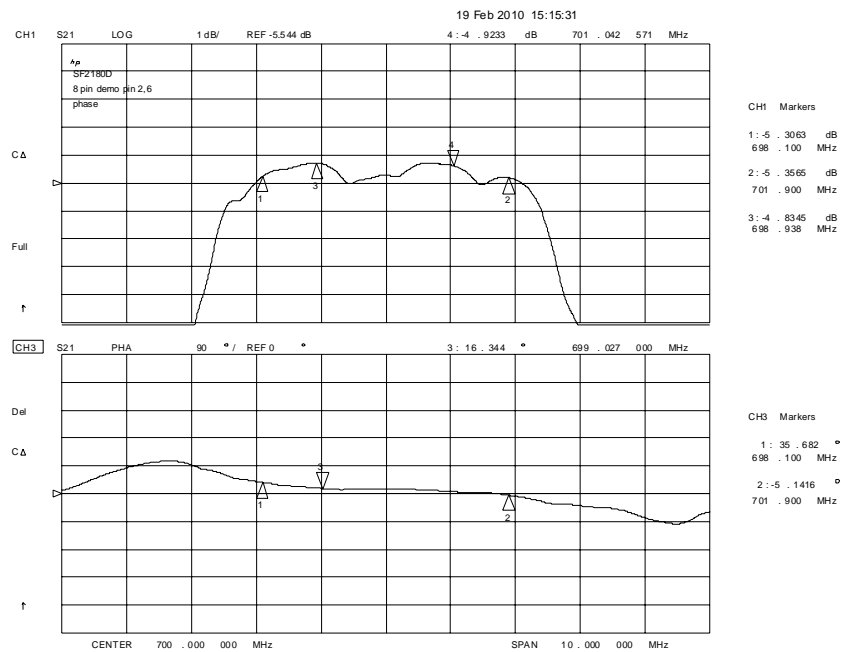
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

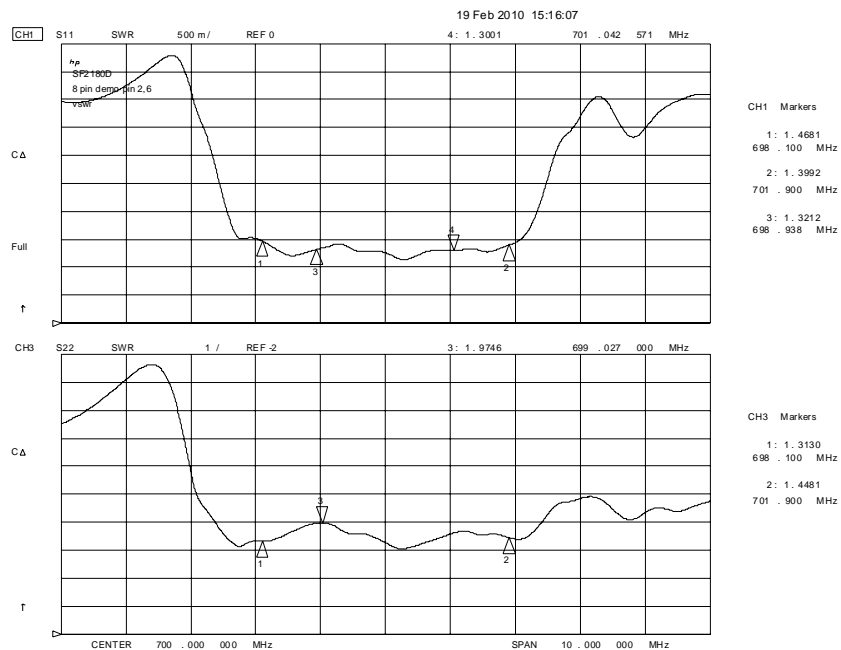
Filter Input/Output Impedance and Amplitude Plots



Filter Passband Amplitude and Phase Plots

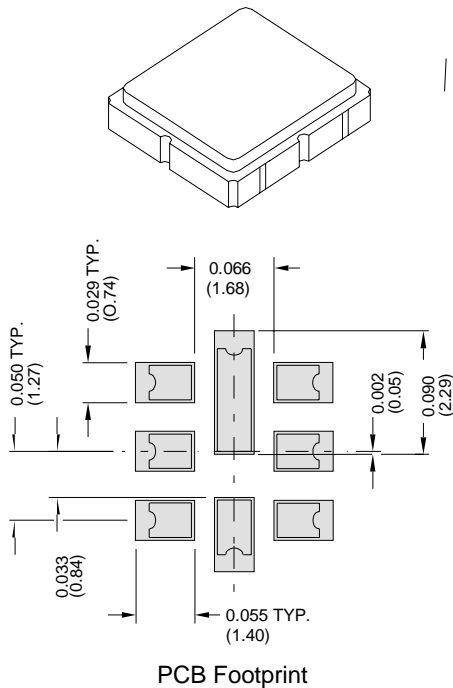


Filter Input and Output SWR Plots



SM3838-8 Case

8-Terminal Ceramic Surface-Mount Case 3.8 X 3.8 mm Nominal Footprint



Case Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	3.6	3.8	4.0	0.142	0.150	0.157
B	3.6	3.8	4.0	0.142	0.150	0.157
C	1.05	1.20	1.35	0.041	0.047	0.053
D	0.95	1.10	1.25	0.037	0.043	0.049
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
H	1.40	1.75	2.05	0.055	0.069	0.080

Electrical Connections

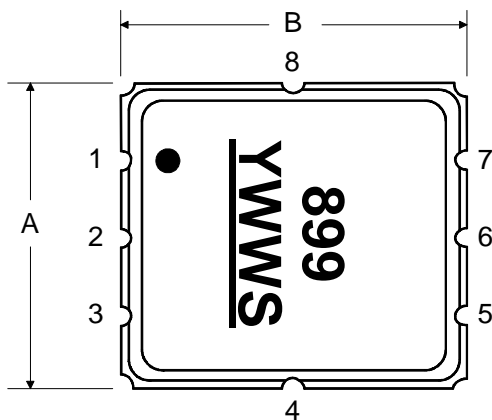
	Connection	Terminals
Port 1	Input	2
Port 2	Output	6
	Ground	All Others

Dot Indicates Pin 1

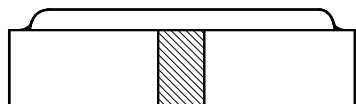
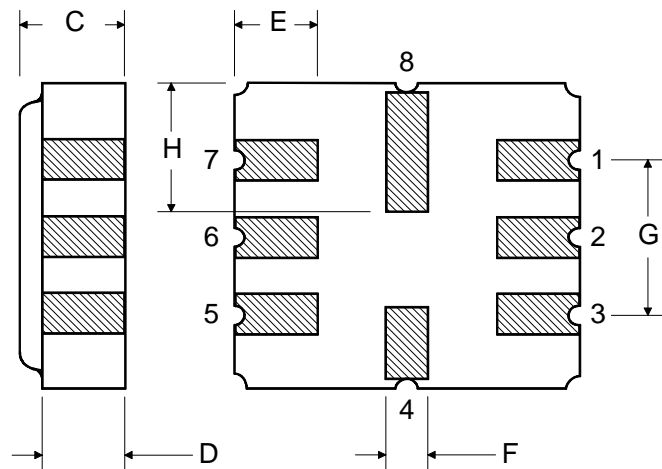
Materials

Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic
Pb Free	

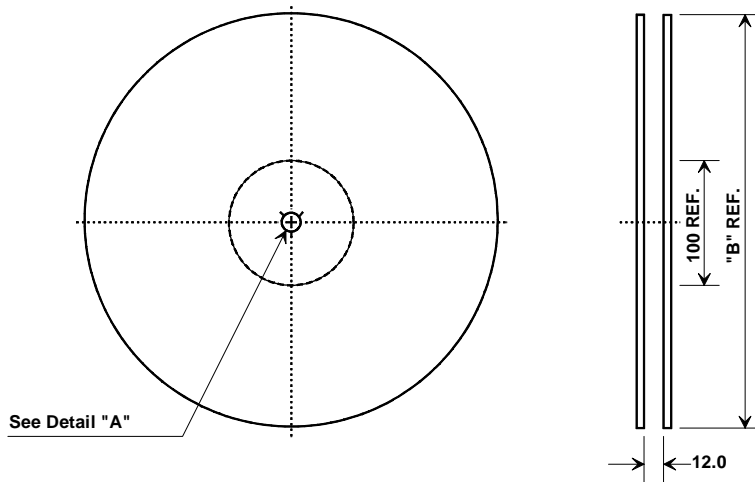
TOP VIEW



BOTTOM VIEW

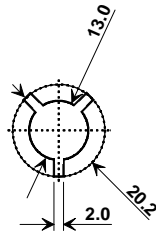


Tape and Reel Specifications



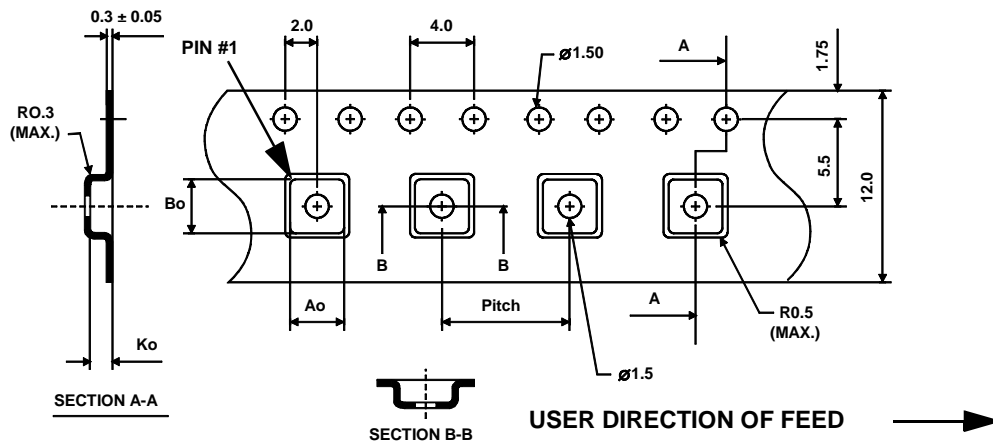
Tape and Reel Standard per ANSI/EIA-481

"B"		Quantity Per Reel
Nominal Size		
Inches	millimeters	
7	178	1000
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

